

Bailey Wu

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EXPERIENCE

Senior Tooling Design Engineer

June 2024 – Current

Seattle, WA

The Boeing Company – Boeing Commercial Airplanes

- Developed detailed 3D models, assemblies, and manufacturing drawings in CATIA V5, applying tolerance stack-up analysis and DFM principles to ensure accurate translation between design intent and physical hardware outcomes.
- Performed simulation-driven mechanical design of production tooling and structural systems, executing Finite Element Analysis (FEA) in ANSYS across static, dynamic, and thermal loading conditions to support design validation.
- Applied stress and fatigue analysis to evaluate structural integrity and long-term durability of production tooling, ensuring designs met aerospace safety and performance requirements across the full operational envelope.
- Maintained engineering data integrity through PLM systems, enforcing version control, documentation accuracy, and full traceability across program phases in compliance with robust aerospace standards.

Senior Materials & Process Engineer

August 2022 – May 2024

Goleta, CA

Raytheon Technologies - Raytheon Vision Systems

- Conducted advanced material testing and characterization including metallurgical analysis, thermal analysis, hardness testing, and microstructure evaluation to validate material behavior and joint integrity of space flight hardware.
- Designed and implemented custom test fixtures and experimental protocols to evaluate material performance under varied loading conditions and environmental exposures, generating actionable data to support process qualification.
- Applied Statistical Process Control (SPC) and Cpk analysis to key performance indicators, improving process capability and reducing variation through data-driven experimental methods analogous to DOE-based characterization workflows.
- Directed procurement and qualification of \$1M+ in capital equipment, authoring technical specifications, overseeing installation and process validation, and delivering measurable improvements in throughput capability.

Semiconductor Process Engineer

March 2021 – August 2022

Goleta, CA

Lockheed Martin – Missiles Fire Control

- Optimized automated assembly lines by integrating precision hardware and custom control logic, developing process interlocks and equipment interfaces to maximize repeatability and reduce operator-introduced variation.
- Conducted failure analysis investigations using cross-sectioning and scanning electron microscopy (SEM), applying systematic root cause analysis methodologies to improve long-term reliability of mission-critical assemblies.
- Presented Production Readiness Reviews (PRR), Critical Design Reviews (CDR), and Table Top Reviews (TTR) to multi-level defense contractor and government stakeholders.
- Developed structured V&V frameworks encompassing non-destructive evaluation, vibration analysis, and thermal cycling to validate process and hardware performance under field environmental conditions.

Manufacturing Engineer

July 2018 – March 2021

Goleta, CA

Raytheon Technologies – Raytheon Vision Systems

- Managed programs using Earned Value Management (EVMS), developing and controlling engineering budgets while overseeing manufacturing and process development for CRAD products transitioning into full scale production.
- Directed hands-on assembly operations within a Class 7, Grade C, Level 3 cleanroom environment, ensuring full compliance with space manufacturing standards in contamination-sensitive laboratory environments.
- Designed prototype builds through additive manufacturing and fabrication, providing hands-on engineering support from shop-floor implementation through full product lifecycle close-out.

EDUCATION

UNIVERSITY OF WASHINGTON

June 2025

Master of Science in Mechanical Engineering

Seattle, WA

UNIVERSITY OF CALIFORNIA, SANTA BARBARA

June 2018

Bachelor of Science in Mechanical Engineering

Santa Barbara, CA

SKILLS

CATIA V5, SolidWorks, PTC Creo, ENOVIA, ANSYS, MATLAB, Python, Minitab, JMP, GD&T, PFMEA, CMM